| | Hits | Search Text | DBs | Time Stamp |
|---|---------|---|---|---------------------|
| 1 | 11920 | boron near (implanting implantation implanted implant) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/07/09 16:14 |
| 2 | 57 | ("6562418" "6436785" "6417031" "6391694" "6380012" "6300209" "6150248" "6133120" "6090590" "5964943" "6097079" "5913131" "5885904" "5866472" "5763320" "5709745" "5672541" "5598025" "5199994" "5198373" "5037767" "4791005" "4692998" "4682564" "4676847" "4318213" "4371587").pn. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/07/08 10:28 |
| 3 | 14 | S1 and S2 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/07/08 10:28 |
| 4 | : 17 | boron near (implanting implantation implanted implant) and solid adj boron | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/07/08 |
| 5 | 3 | "6904509".pn. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/07/08 10:28 |
| 6 | 0 . | S1 and S5 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/07/08 10:31 |
| 7 | 290 | solid adj boron | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/07/09 16:13 |
| 8 | 1135 | solid adj3 boron | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/07/08 10:31 |

| | Hits | Search Text | DBs | Time Stamp |
|----|------|--|---|---------------------|
| 9 | 65 | S1 and S8 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/07/08 10:31 |
| 10 | 39 | solid adj boron and boron adj2 (ion ions plasma) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/07/08 10:32 |
| 11 | 107 | S8 and boron adj2 (ion ions plasma) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/07/09 16:09 |
| 12 | 85 | solid adj boron and semiconductor | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/07/08 10:32 |
| 13 | 319 | solid adj3 boron and semiconductor | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB | 2005/07/08 10:32 |
| 14 | 80 | solid adj3 boron and semiconductor and boron adj2 (ion ions plasma) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM TDB | 2005/07/08 10:34 |
| 15 | 27 | solid adj boron and semiconductor and boron adj2 (ion ions plasma) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/07/08 10:34 |
| 16 | 43 | solid adj3 boron and semiconductor and boron adj2 (ion ions plasma) and S1 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/07/08 10:34 |
| 17 | 12 | solid adj boron and semiconductor and boron adj2 (ion ions plasma) and S1 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/07/08 10:34 |

| | Hits | Search Text | DBs | Time Stamp |
|----|------|----------------------------------|---|---------------------|
| 18 | 117 | 438/513.ccls. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/07/08 10:45 |
| 19 | 13 | 438/513.ccls. and S1 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/07/08 10:45 |
| 20 | 2 | 438/513.ccls. and S1 and (S7 S8) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/07/08 10:46 |
| 21 | 5 | 438/513.ccls. and (S7 S8) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/07/08 10:46 |
| 22 | 1086 | 438/514.ccls. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/07/08 10:45 |
| 23 | 119 | 438/514.ccls. and S1 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/07/08 10:45 |
| 24 | 4 | 438/514.ccls. and S1 and (S7 S8) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/07/08 10:46 |
| 25 | 6 | 438/514.ccls. and (S7 S8) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/07/08 10:46 |
| 26 | 1135 | solid adj3 boron | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/07/09 16:09 |

| | Hits | Search Text | DBs | Time Stamp |
|----|------|--|---|---------------------|
| 27 | 1111 | S26 and boron adj2 (ion ions plasma) and germanium | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/07/09 16:11 |
| 28 | 5 | S26 and boron adj2 (ion ions plasma) and germanium with boron | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/07/09 16:11 |
| 29 | 17 | | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/07/09 16:13 |
| 30 | 73 | implantation implanted implant) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/07/09 16:14 |
| 31 | 3.8 | implantation implanted implant) with germanium and boron adi | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | 2005/07/09 16:15 |